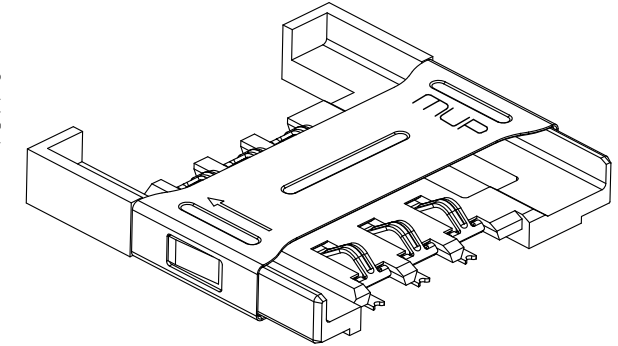
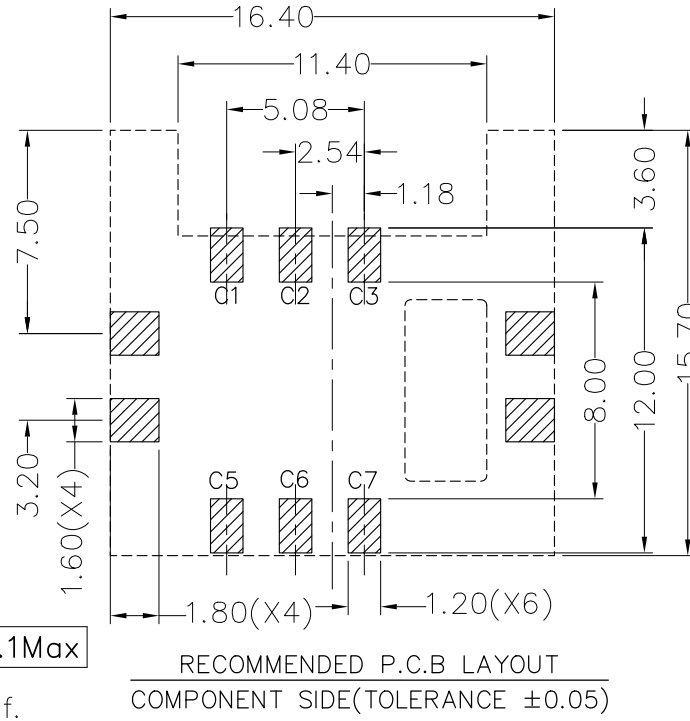
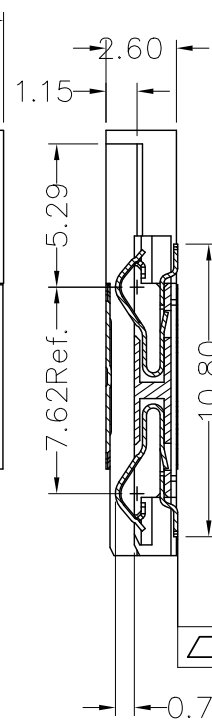
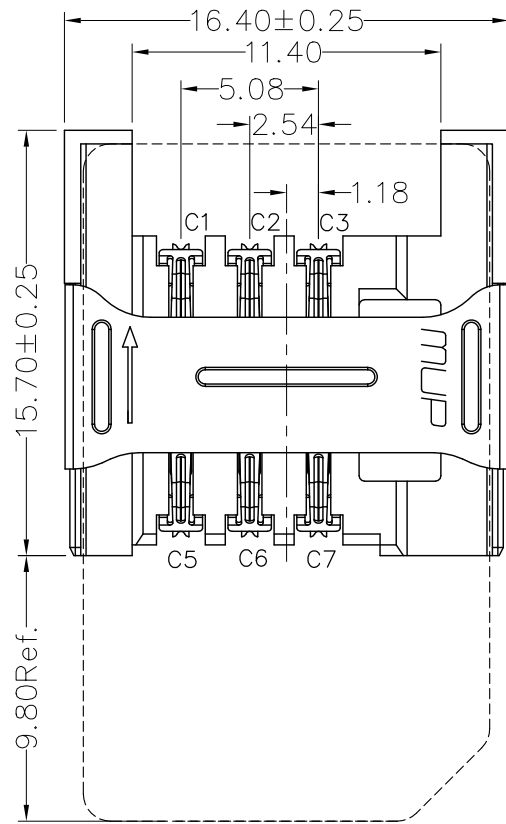


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1					
X2					



TECHNICAL CHARACTERISTICS

1.General Characteristics

Dimensions: 15.70LX16.40WX2.60H mm

Weight: Approx 0.52±0.2g

Durability: 5,000 cycles min.

2.Electrical Characteristics

Contact resistance: 50mΩ typical, 100mΩ max

Insulation resistance: >1000MΩ/500V DC

3.Solderability

Vaporphase: 215°C, 30sec.Max

IR reflow: 250°C, 5sec.Max

Manual soldering: 370°C, 3sec.Max

4.Environmental Characteristics

Operating temperature: -40°C~+85°C

Operating humidity: 10%~+95%RH

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	HOUSING	1	LCP+30%GF	Black UL94V-0
2	DATA CONTACT	6	Copper Alloy	Contact area:Gold plated
3	SHELL	1	Stainless Steel	SMT area:Gold plated

Unless otherwise specified, other tolerance are:		MUP MUP INDUSTRIAL CO.,LTD. NAME: SIM Card Connector MODEL NO: MUP C742-1 TYPE : H2.60 Without post 6p	
X	±0.35	X*	±5°
X.X	±0.25	X.X*	±4°
X.XX	±0.15	X.XX*	±3°
X.XXX	±0.10	X.XXX*	±2°

PROJ.	UNIT	SCALE	DRAWN	Zeoy Dec.07.2009	DWG NO.:	DWG-MUP-C742-001	
CHECKED	Sean Dec.07.2009		APPROVAL	Jun Dec.07.2009	SHEET	1/1	REVISION
CUSTOMER DRAWING							X1

